Call for Papers Open for SEMICON Europa 2013

SEMI

BERLIN, Germany — February 19, 2013 — SEMI today announced the "Call for Papers" for technical sessions and presentations for the upcoming SEMICON Europa 2013 which takes place October 8-10 in Dresden, Germany. Technical presentation abstracts are due May 24.

SEMICON Europa 2013 will feature more than 100 hours of technical sessions and presentations focused on critical industry topics that are shaping the design and manufacturing of semiconductors, MEMS/MST, printed and flexible electronics, and other related technologies.

Abstracts for presentations are now being accepted for:

- International MEMS/MST Industry Forum; theme: "Taking MEMS to the Next Level"
- Advanced Packaging Conference; theme: "The Power of Packaging"
- 15th European Manufacturing Test Conference (EMTC); theme: "Semiconductor Test: A Reactive or Proactive Industry?"
- 450mm Session; theme: "450mm: Towards Global Cooperation"

Parallel to the SEMICON Europa 2013, the Plastic Electronic Conference (PE2013) will also take place in Dresden from October 8-10.

Abstracts for presentations are now being accepted for:

- OLEDs for Displays and Lighting
- Flexible Photovoltaic
- Integrated Smart Systems

Prospective presenters are invited to submit abstracts (1,000-2,000 characters). Material must be original, non-commercial and non-published. Abstracts must clearly detail the nature, scope, content, organization, key points and significance of the proposed presentation. Please use this link (www.semiconeuropa.org/ProgramsandEvents/CallforPapers [1]) to submit your abstract and biography.

For more information about the conference or submitting abstracts, including guidelines and requirements, please visit the SEMICON Europa 2013 [2] "Call for Papers" homepage [1] or contact Christina Fritsch [3], SEMI Europe, at Tel. +49 30

3030 8077 – 18 or cfritsch@semi.org.

The deadline for submitting abstracts is May 24, 2013.

About SEMICON Europa

SEMICON Europa is the annual premier event for the global microelectronics industry in Europe. The event covers the display of new products and technologies for microelectronics design and manufacturing, and features technologies from across the microelectronics supply chain, from electronic design automation, to device fabrication (wafer processing), to final manufacturing (assembly, packaging, and test). SEMICON Europa also features emerging markets and technologies, including micro-electromechanical systems (MEMS), flexible electronics and displays, nano-electronics, solid state lighting (LEDs), and related technologies. For more information on SEMICON Europa, please visit: www.semiconeuropa.org [2]

About SEMI

SEMI is the global industry association serving the nano- and microelectronic manufacturing supply chains. SEMI member companies are the engine of the future, enabling smarter, faster and more economical products that improve our lives. Since 1970, SEMI has been committed to helping members grow more profitably, create new markets and meet common industry challenges. SEMI maintains offices in Bangalore, Beijing, Berlin, Brussels, Grenoble, Hsinchu, Moscow, San Jose, Seoul, Shanghai, Singapore, Tokyo, and Washington, D.C. For more information on SEMI, visit www.semi.org [4].

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